

Infrared brazing of TiAl using Al-based braze alloys

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Abstract

A novel approach for joining TiAl by infrared vacuum brazing using pure aluminum and BAlSi-4 filler metal has been reported in the study. For pure Al filler metal, the extensive presence of stable TiAl₃ phase in the joint results in inherent brittleness of the bond, and it is difficult to completely remove the stable TiAl₃ by heat treatment after infrared brazing. For BAlSi-4 filler metal, the matrix of the braze alloy is mainly comprised of Al alloyed with Si and Ti. Both Si-rich and a few Al–Fe–Si intermetallics are also observed in the braze. The transient interfacial AlSi₃Ti₂ phase is only observed in the short brazing cycle. The stable Al₁₂Si₃Ti₅ phase dominates the interface between braze and TiAl substrate. For 800 °C brazing, the shear strength increases from 43.2 MPa to 63.9 MPa upon increasing the brazing time. The brazed specimens are failed at the interface between Al₁₂Si₃Ti₅ phase and braze alloy, and the fractured surface is rich in Si. For 900 °C brazing, the shear strength keeps about the same level upon brazing at 120–300 seconds, and its maximum shear strength is 86.2 MPa. For specimens brazed below 120 s, the specimens are fractured at the interface between Al₁₂Si₃Ti₅ and braze alloy. With increasing the brazing time, the thickness of Al₁₂Si₃Ti₅ layer is increased, and the fracture mode changes from the interface into Al₁₂Si₃Ti₅ layer. Further increasing the brazing time, the fractured location changes again from Al₁₂Si₃Ti₅ layer into the braze alloy itself.

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1. Introduction

Titanium aluminides including Ti₃Al, TiAl, TiAl₂ and TiAl₃ are featured with ordered structure, low density and high melting points. Among these alloys, TiAl is the most promising alloy due to its high specific strength, good corrosion resistance and excellent creep strength [1–10]. Considerable efforts have been focused on both alloy design and process improvements of the titanium aluminides with modified mechanical properties and corrosion resistance for structural applications [11–16]. Additionally, many manufacturing processes, such as directional solidification, superplastic forming and heat-treating, have also been extensively studied [12,17–24]. A variety of TiAl components have been successfully tested in aerospace and automobile industry [7].

Joining of titanium aluminides always plays an important role in the application of such alloys. The

bonding of titanium aluminides is more difficult to achieve compared to many other engineering alloys due to the high reactivity of TiAl and the tendency to form brittle intermetallic phase in the joint. It is reported that successful bonding can be obtained by diffusion bonding, friction welding, vacuum brazing and induction brazing [3,25,26]. Brazing is a good choice in bonding alloys, which are difficult to be joined by the traditional welding process. The use of silver, copper, gold, titanium and nickel base braze alloys in joining TiAl intermetallics has been reported in literatures [25–27]. In addition to the above braze alloys, aluminum based braze alloys are featured with low density and moderate corrosion resistance. The TiAl infrared brazed joint obtained using aluminum foil as filler metal has already been reported [28]. Therefore, aluminum based braze alloys could be an alternative in the vacuum brazing of TiAl.

The rapid infrared joining technique has been originally developed at the University of Cincinnati for high temperature materials [29]. Infrared vacuum brazing makes use of infrared energy generated by heating a tungsten filament in a quartz tube as the heating source

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[30–33]. The infrared rays transmitted through the quartz tube are focused on the specimen. The specimen is heated by infrared rays, and the furnace is not heated during the brazing process. Therefore, infrared brazing is a highly potential process with the characteristics of rapid thermal cycle [29,30]. The present work reports a new approach in joining TiAl by infrared brazing using two aluminum-based braze alloys. Both the microstructural evolution of the brazed joint and shear strength are studied in order to evaluate the relation between microstructure and joint performance.

2. Experimental procedures

The master alloy with the nominal composition Ti₅₀Al₅₀ (in at.%) was prepared by vacuum arc remelting of high purity (> 99.99 wt.%) Ti rods and Al pellets. Both Ti rods and Al pellets were cleaned by 1HF–15HNO₃–64H₂O (in ml) and saturated NaOH solution prior to vacuum arc remelting. The vacuum arc remelting was performed at least six times, and the final weight loss of the master alloy was below 0.1 wt.%. The master alloy was homogenized subsequently at 950 °C for 100 h. Two aluminum-based filler metals, pure Al and BAlSi-4 alloy tapes, were used as the brazing filler metals. Based on the AWS specification of aluminum based braze alloys, the chemical composition of BAlSi-4 alloy in weight percent was (11–13)Si, 0.3Cu, 0.1Mg, 0.2Zn, 0.15Mn, 0.8Fe [34]. The solidus and liquidus

temperatures of this alloy are 577 and 582 °C, respectively. The thickness of the braze alloy tape was 75 μm throughout the experiment.

Compared with the traditional furnace brazing, infrared brazing is featured with rapid thermal cycle [29,30]. Unlike furnace brazing, higher infrared brazing temperature will do less damage to the base metal. Additionally, high brazing temperature can greatly speed up the microstructural evolution of the brazed joint. Consequently, higher brazing temperatures were chosen in the study. Infrared brazing was performed under 8×10⁻⁵ mbar vacuum, and the heating rate was set at 900 °C/min throughout the experiment. All specimens were preheated at 400 °C for 60 s before heating the specimens to the brazing temperatures. For the pure Al filler metal, the specimen was brazed at 900 °C, 1000 °C and 1100 °C for 60–180 s. For the BAlSi-4 filler alloy, the process variables used in brazing TiAl are summarized in Table 1.

The size of the brazed specimen was 10.0 mm×10.0 mm×2.5 mm. All joined surfaces were polished by SiC papers up to grit 1200, and ultrasonically cleaned by acetone prior to infrared brazing. The area of filler

Table 1
Process variables of BAlSi-4 filler used in infrared brazing TiAl

Brazing time (s)	800 °C	900 °C
15	O	O
30	O	O
45	O	O
60	O/Δ	O/Δ
90	O	O
120	O/Δ	O/Δ
180	O/Δ	O/Δ
240	O/Δ	O/Δ
300	O/Δ	O/Δ

O: metallographic observation specimen, Δ: shear test specimen.

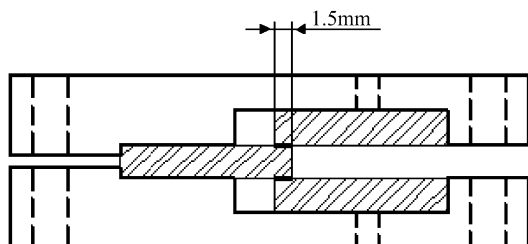


Fig. 1. A schematic diagram of the specimen used in the shear test.

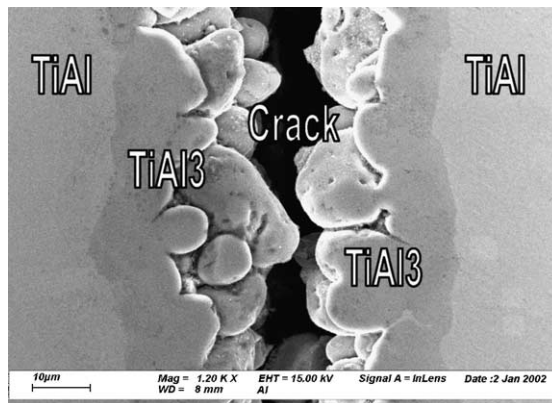


Fig. 2. The SEI of TiAl/Al/TiAl specimen brazed at 900 °C for 30 s.

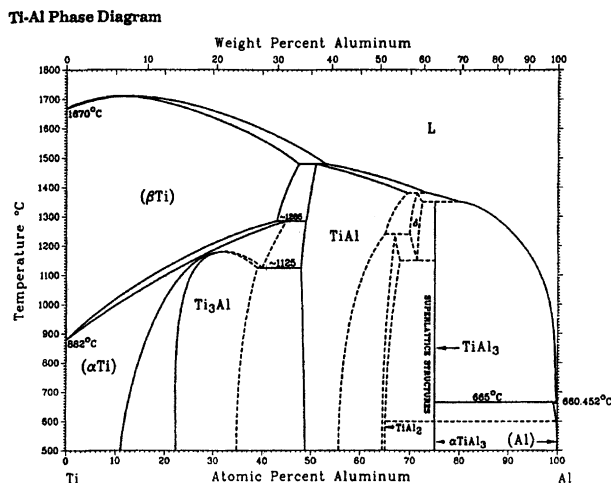


Fig. 3. Ti–Al binary alloy phase diagram [35].

metal was approximately the same size as that of the base metal. To enhance the absorption of infrared rays, a graphite fixture was used during brazing as described in the previous studies [30–33]. Specimens were sandwiched between two graphite plates. A thermocouple was inserted into the upper graphite plate, which was in contact with the brazed specimen. There is a time delay between the actual specimen temperature and programmer temperature, so that time compensation is necessary in the present experiment. The brazing time

specified in the test is the actual specimen holding time in the experiment [30].

The brazed sample was cut by a low speed diamond saw, and was followed by a standard metallographic procedure. The cross-sections of the brazed specimens were examined using Phillips XL-30 scanning electron microscope (SEM) and a LEO 1530 field emission scanning electron microscope (FESEM) with an accelerating voltage of 15 kV. Quantitative chemical analysis was performed by using a JEOL

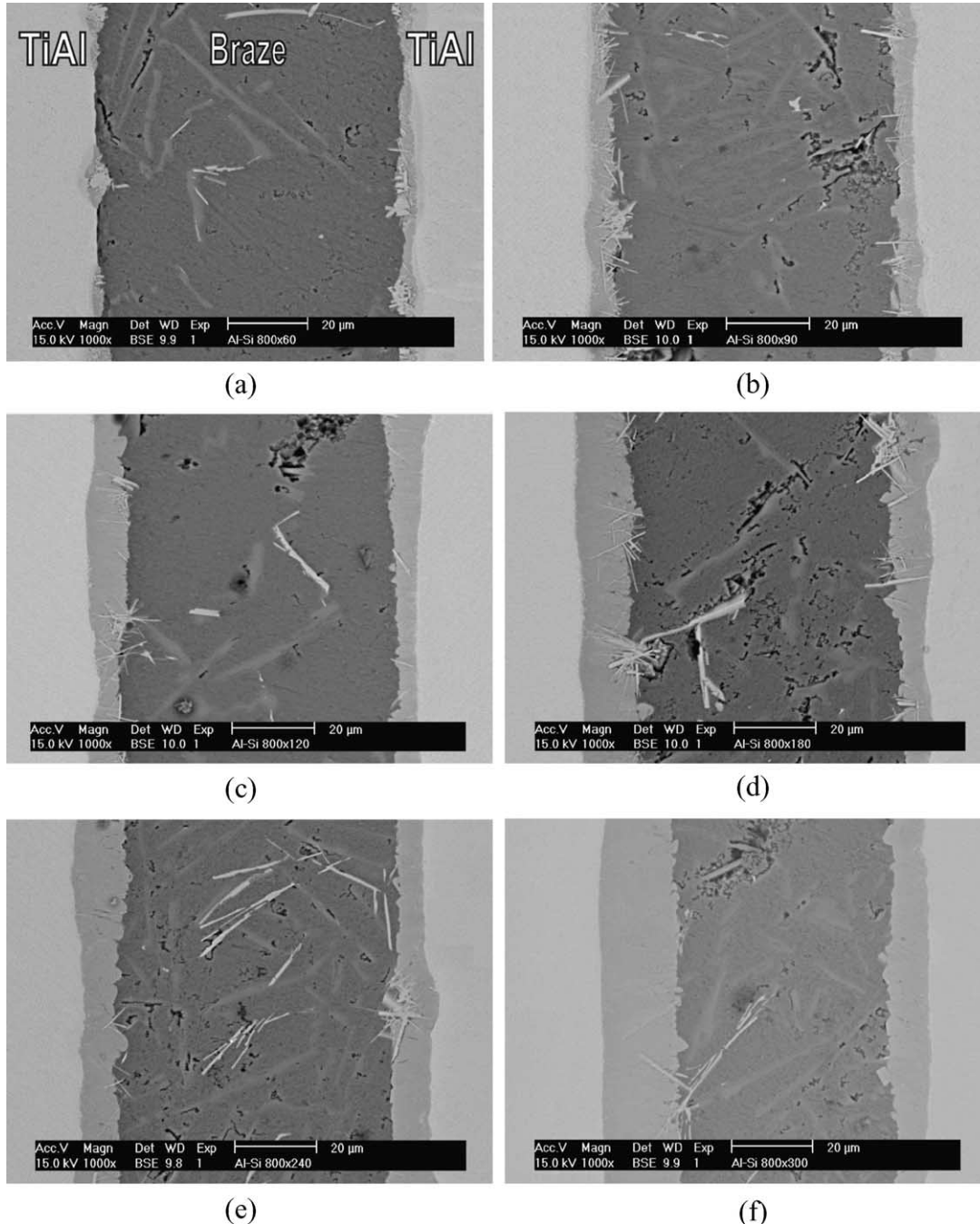


Fig. 4. The BEIs of the SEM observations for TiAl/BAlSi-4/TiAl specimen brazing at 800 °C for (a) 60 (b) 90 (c) 120 (d) 180 (e) 240 and (f) 300 s.

JXA-8800M electron probe microanalyzer (EPMA) equipped with a wavelength dispersive spectrometer (WDS). Its spot size was 1 μm , and its operation voltage was 15 kV.

Microhardness measurements were made using a microhardness tester (Akashi MVK-E II) with a load of 10 g and a duration time of 15 s. The experimental data were averaged from 10 measurements of each brazing condition. A shear test was performed by the Shimadzu AG-10 universal testing machine to evaluate the bonding strength of the brazed joint. Fig. 1 shows a schematic

diagram of the specimen used in the shear test. The shaded area is the TiAl base metal, and the outer part of the layout is the graphite fixture used in the infrared brazing furnace. The two 1.5 mm wide bold black lines in the middle of the graph represent the braze filler alloy. The brazed specimen was compressed by a universal testing machine with a constant speed of 1 mm/min. The structure analysis of the fracture surface after the shear test was performed using a Philips PW1710 X-ray diffractometer (XRD), and Cu K_{α} was selected as the X-ray source.

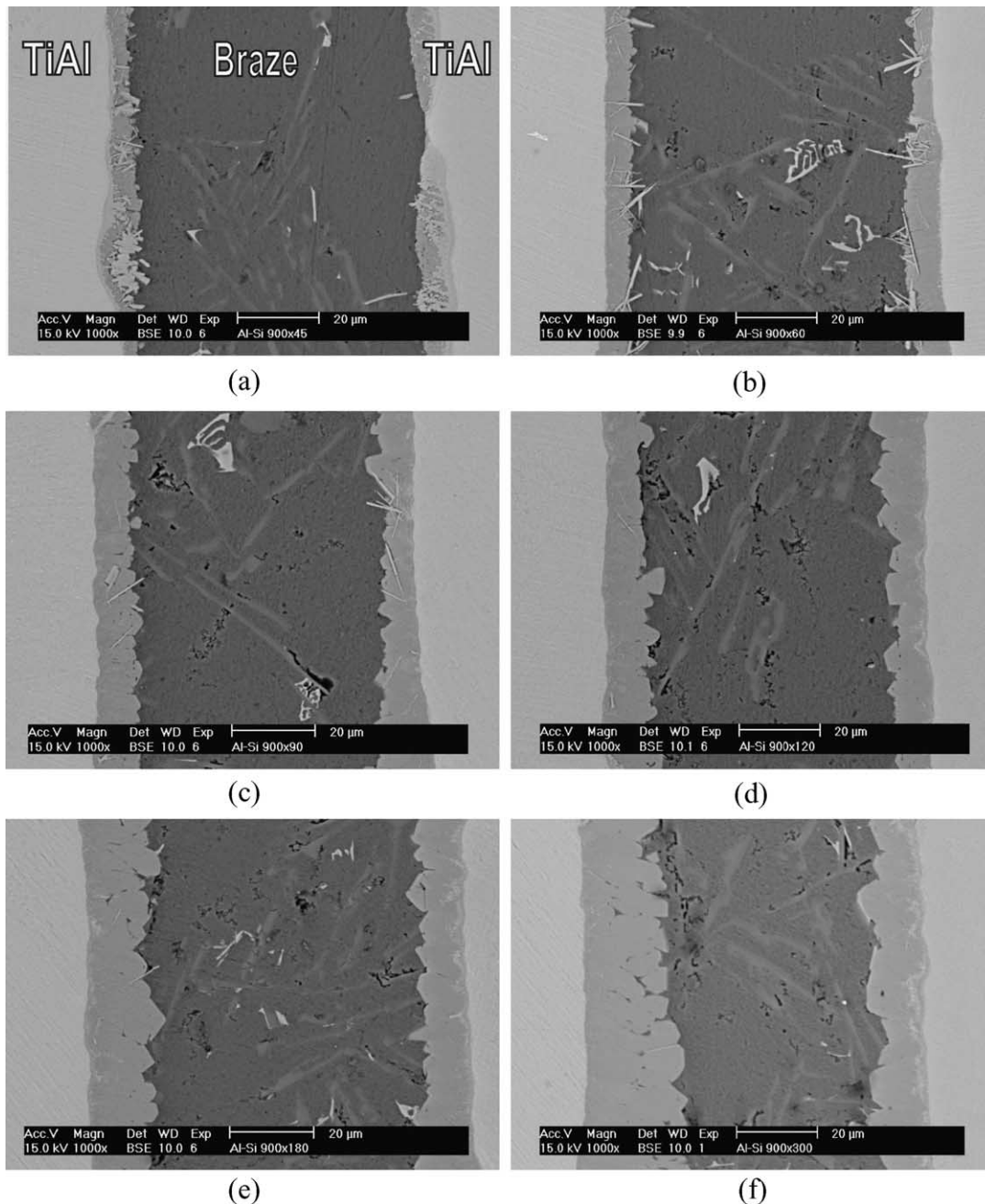


Fig. 5. The BEIs of the SEM observations for TiAl/BA1Si4/TiAl specimen brazing at 900 °C for (a) 45 (b) 60 (c) 90 (d) 120 (e) 180 and (f) 300 s.

3. Results and discussion

3.1. Microstructural observations of the infrared brazed TiAl/Al/TiAl

For the pure Al filler, the bonding strength of all infrared brazed specimens was too weak to be evaluated in the experiment. All brazed joints were debonded upon cross section of specimens. Fig. 2 shows the secondary electron image (SEI) of the TiAl/Al/TiAl specimen brazed at 900 °C for 30 s. A major crack can be observed in the middle of the micrograph. The microhardness of the brazed joint is Hv 330, which is higher than that of TiAl base metal with Hv 253. According to EPMA chemical analysis, brittle TiAl_3 phase is the primary phase in the joint. Fig. 3 displays the Ti–Al binary alloy phase diagram [35]. According to the figure, it is expected that stable TiAl_3 phase can be formed for specimens brazed below 1350 °C. The extensive presence of stable TiAl_3 phase in the joint results in inherent brittleness of the bond, and it is difficult to completely remove the stable TiAl_3 by heat treatment after infrared brazing. Therefore, no further evaluation is performed in the TiAl/Al/TiAl joint.

3.2. Microstructural evolution of the infrared brazed TiAl/BAISi-4/TiAl

Fig. 4(a)–(f) show the backscattered electron images (BEIs) of the SEM observations for TiAl/BAISi-4/TiAl specimen brazed at 800 °C for 60, 90, 120, 180, 240 and 300 s. Solidification shrinkage voids in the braze for all specimens can be seen, which is not unusual in brazing, since the brazing experiences a solidification process. In many brazed joints, a fraction of the joint volume will comprise residual voids that are not derived from trapped air or gas [36]. These residual voids are extremely difficult to remove because they are intrinsic to the filler metal, being caused by shrinkage upon solidification [36]

In Fig. 4, it is clearly observed that there is at least one continuous layer between BAISi-4 alloy and TiAl substrate, and the thickness of the reaction layer is increased upon increasing the brazing time. Similar results can be obtained if the brazing temperature increases from 800 °C to 900 °C as shown in Fig. 5. It is essential to perform an EPMA chemical analysis in order to unveil the microstructural evolution of the brazed joint.

According to Fig. 5, TiAl/BAISi-4/TiAl brazed joint at 900 °C for 45 s demonstrates complex interfacial reactions, so it has been chosen in the chemical analysis. Fig. 6 shows the FESEM BEI observation and EPMA chemical analysis results of TiAl/BAISi-4/TiAl specimens brazed at 900 °C for 45 s. The matrix of the braze is mainly comprised of Al-rich matrix alloyed with minor Si and Ti as marked by D, and there is a gray

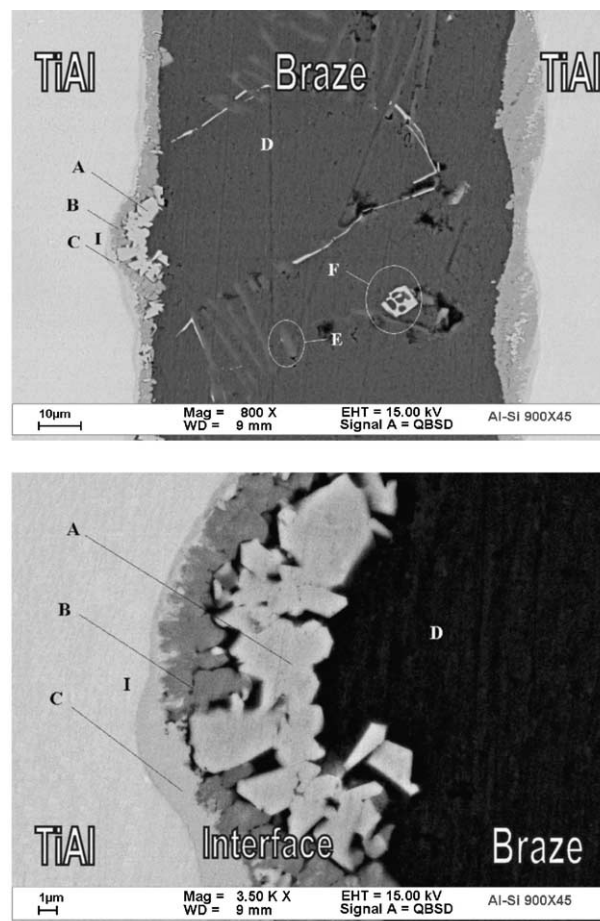
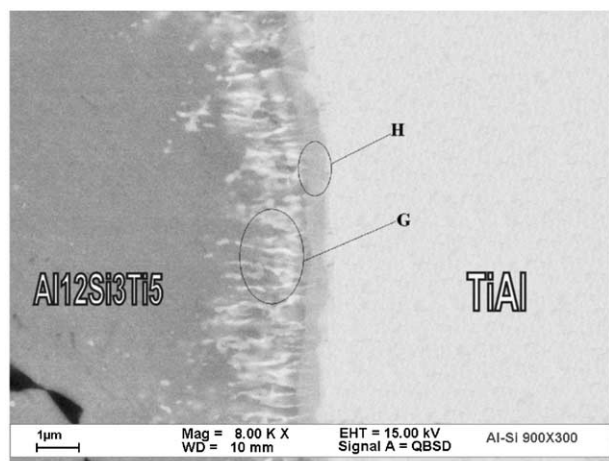
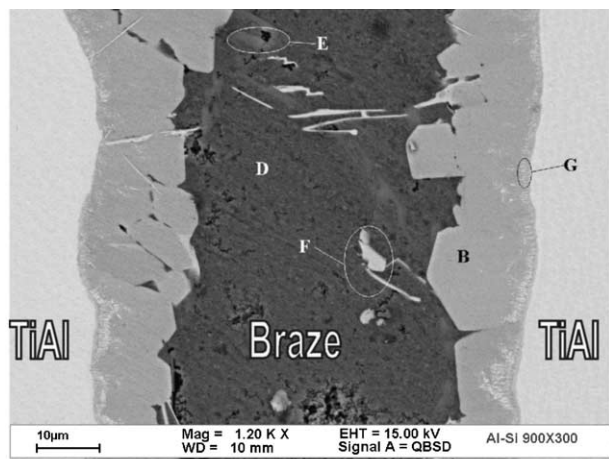


Fig. 6. The FESEM BEI observations and EPMA chemical analysis results of TiAl/BAISi-4/TiAl specimens brazed at 900 °C for 45 s.

streak-like Si-rich phase as marked by E in the figure. The TiAl substrate is alloyed with Si as marked by I in Fig. 6. It is also observed that there are several phases at the interface between the braze alloy and TiAl base metal. According to the Al–Si–Ti ternary alloy phase diagram, the stoichiometry of both the phases A and C is very close to AlSi_3Ti_2 , and the stoichiometry of phase B is close to $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ [37]. It is noted that AlSi_3Ti_2 at the interface is prominent only at the early stage of infrared brazing. The amount of AlSi_3Ti_2 phase at the interface is greatly decreased upon increasing either the brazing temperature or brazing time as shown in Figs. 4 and 5. If the specimen brazing at 900 °C exceeds 120 s, AlSi_3Ti_2 phase is disappeared completely. Additionally, it is worth noting that the interfacial AlSi_3Ti_2 phase is not continuous.

Different from the AlSi_3Ti_2 phase, the continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ (marked by B in Fig. 6) grows rapidly and

dominates the interfacial reaction upon increasing the brazing time. Fig. 7 shows the FESEM BEI observations and EPMA chemical analysis results of TiAl/BAISi-4/TiAl specimens brazed at 900 °C for 300 s. Three phases are observed in the braze, including: Al-rich matrix (marked by D), Si-rich phase (marked by E) and minor Al–Fe–Si intermetallics (marked by F). It is observed that a little Al–Fe–Si phase exists in the braze after infrared brazing, and the formation of Al–Fe–Si intermetallics can be attributed to the minor Fe content in the BAISi-4 braze alloy. Similar to the aforementioned result, continuous Al₁₂Si₃Ti₅ phase is the stable interfacial phase in the joint as marked by B in Fig. 7. Additionally, a thin layer of TiAl₂ alloyed with minor Si is observed as marked by H in Fig. 7. There is one phase marked by G in the figure, and any known stoichiometric



Wt%/ At%	B	D	E	F	G	H
Ti	38.2/ 25.9	0.3/ 0.2	0.2/ 0.2	0.1/ 0.1	46.1/ 32.6	50.5/ 36.5
Al	52.3/ 63.1	99.2/ 99.3	11.2/ 11.6	48.4/ 57.0	43.6/ 55.0	48.3/ 62.0
Si	9.5/ 11.0	0.5/ 0.5	88.6/ 88.2	24.1/ 27.3	10.3/ 12.4	1.2/ 1.5
Fe	---	---	---	27.4/ 15.6	---	---
Phase	Al ₁₂ Si ₃ Ti ₅	Al-rich	Si-rich	Al-Fe-Si	---	TiAl ₂

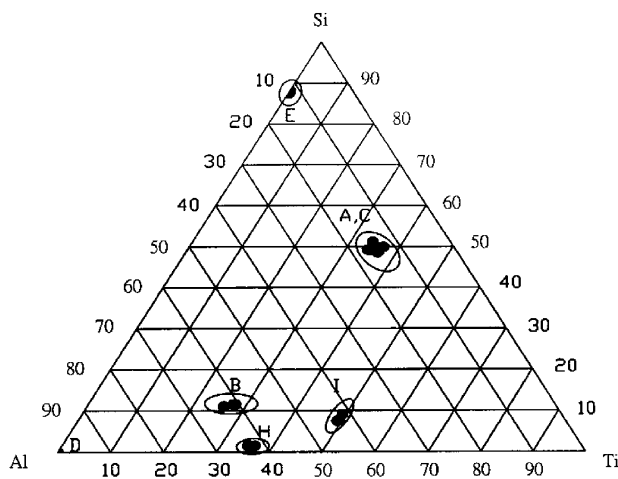
Fig. 7. The FESEM BEI observations and EPMA chemical analysis results of TiAl/BAISi-4/TiAl specimens brazed at 900 °C for 300 s.

compounds in the ternary alloy phase diagram cannot categorize its chemical composition. It is believed that phase G is formed via solid-state interdiffusion between Al₁₂Si₃Ti₅ and TiAl₂.

Fig. 8 summarizes the EPMA chemical analysis results of various phases across the joint. The matrix of the braze alloy is mainly comprised of Al alloyed with minor Si and Ti. Both Si-rich and Al–Fe–Si intermetallics are observed in the braze. However, the amount of Al–Fe–Si intermetallics is very much limited due to insufficient Fe content in the BAISi-4 braze filler. The initially transient interfacial AlSi₃Ti₂ phase is only observed either at lower brazing temperatures or at short brazing cycle. The TiAl₂ phase alloyed with minor Si is observed for longer brazing time. The stable interfacial Al₁₂Si₃Ti₅ phase is formed initially and grows steadily during brazing. The evaluation of these phases on bonding strength of the infrared brazed specimen will be discussed in the next section.

3.3. Shear test of the infrared brazed TiAl/BAISi-4/TiAl

Fig. 9 shows the shear strength of infrared brazed specimens at various brazing conditions. For specimens infrared brazed at 800 °C, the shear strength increases as the brazing time increases from 120 to 300 s. The shear strength increases from 43.2 MPa to 63.9 MPa upon increasing the brazing time. Additionally, the shear strength obtained for the 800 °C sample (60 s) is too low to be evaluated. In contrast to the specimens brazed at 800 °C, the shear strength obtained is about



Mark	A, C	B	H	I	D	E
Phase	AlSi ₃ Ti ₂	Al ₁₂ Si ₃ Ti ₅	TiAl ₂ (Si)	TiAl(Si)	Al-rich	Si-rich
Location	interface	interface	interface	substrate	braze	braze
Quantity	minor	major	minor	base metal	major	minor

Fig. 8. Summarized EPMA chemical analysis results of various phases in the joint.

the same level for specimens brazed at 900 °C for 120–300 s, and its maximum shear strength is 86.2 MPa.

Cross-sections of the above fractured specimens are mounted in an epoxy, and examined by an SEM. Since the sample was broken after shear test, only one of the broken pieces was chosen for SEM failure analysis. Fig. 10 illustrates the cross section of the shear-test of TiAl/BAISi-4/TiAl joint infrared brazed at 800 °C for 120, 180, 240 and 300 s. There are arrows in the figure

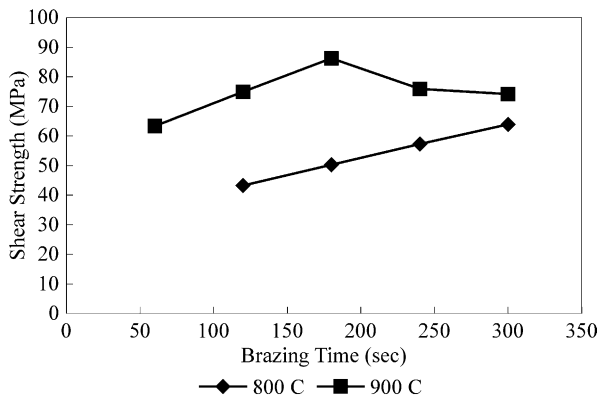


Fig. 9. The shear strength of infrared brazed specimens for various brazing conditions.

indicating the location of crack. All cracks are along the interface between continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer and the braze alloy as shown in Fig. 10. It is noted that the continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer is not shown in Fig. 10(c) and (d), since the continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer is located in the other part of the fractured specimen.

Fig. 11 illustrates the cross section of the shear-tested TiAl/BAISi-4/TiAl joint infrared brazed at 900 °C for 60, 120, 180, 240 and 300 s. Similar to Fig. 10, the fractured location shown in Fig. 11(a) is along the interface between continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer and the braze alloy. Different from Fig. 11(a), the crack is initiated and propagated in the continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer as displayed in Fig. 11(b) and (c). In Fig. 11(d) and (e), the cracks are located in the braze alloy itself.

There are three types of cracks observed in the experiment as summarized in Fig. 12. It is noted that a reaction layer ($\text{Al}_{12}\text{Si}_3\text{Ti}_5$) between the TiAl substrate and BAISi-4 filler metal has been generated after infrared brazing as displayed in Fig. 12. Mode I crack is along the interface between continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer and the braze alloy as shown in Figs. 10 and 11(a). Mode II cracks are initiated and propagated along the continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer as displayed in Fig. 11(b) and (c). Finally, mode III

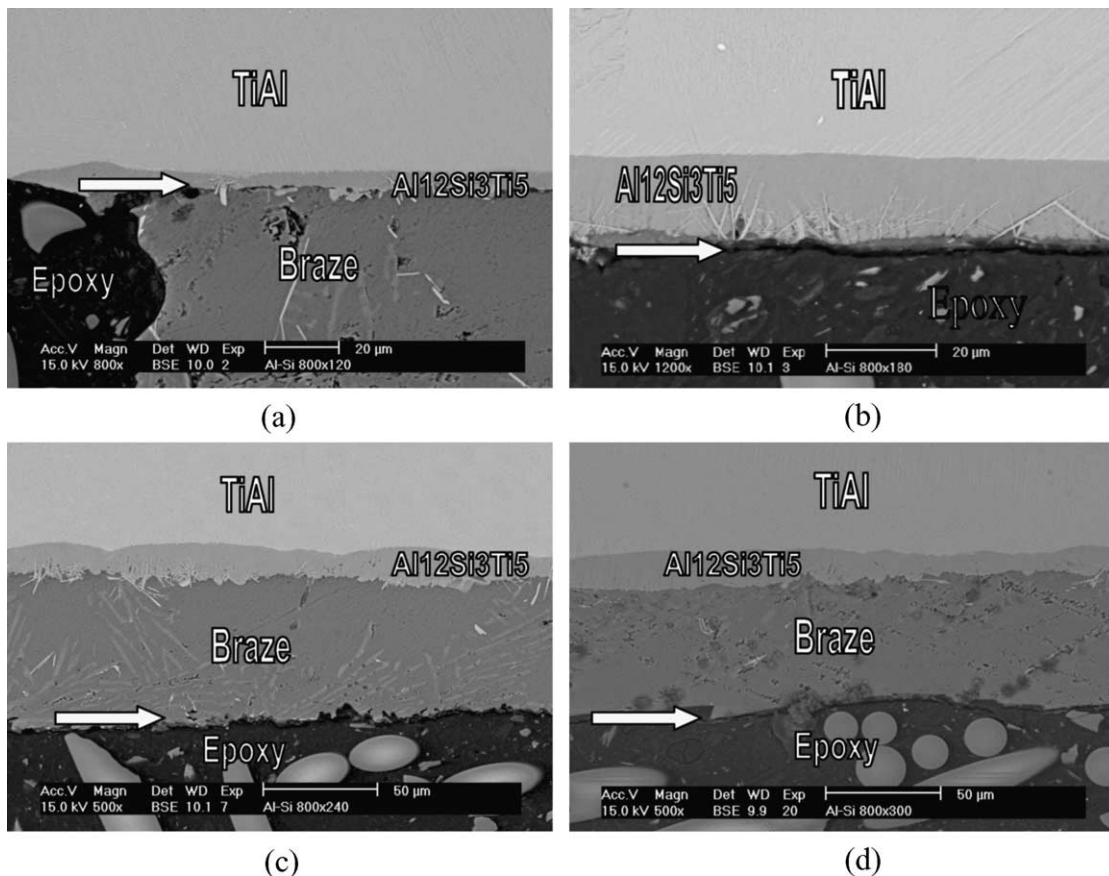


Fig. 10. Cross sectional SEM images of the TiAl/BAISi-4/TiAl joint after shear test infrared brazing at 800 °C for (a) 120, (b) 180, (c) 240 and (d) 300 s.

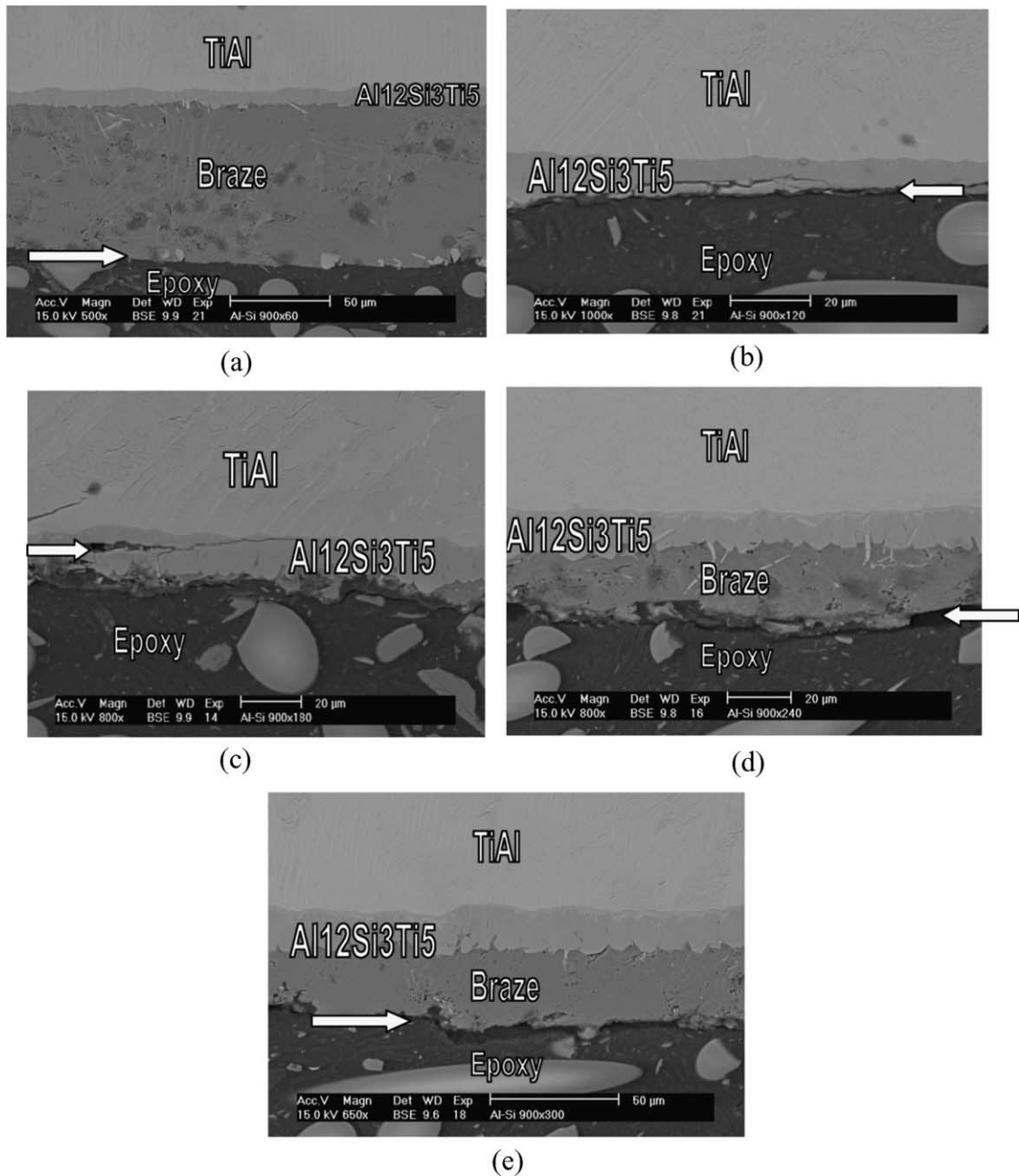


Fig. 11. Cross section al SEM images of the TiAl/BAISI-4/TiAl joint after shear test infrared brazing at 900 °C for (a) 60, (b) 120, (c) 180, (d) 240 and (e) 300 s.

Table 2

The chemical analyses of fractured surfaces after shear test for specimens infrared brazed at 900 °C

Brazing time (s)	60		120		180		240		300	
Mode (location)	Mode I (interface)		Mode II, (Al ₁₂ Si ₃ Ti ₅)		Mode II, (Al ₁₂ Si ₃ Ti ₅)		Mode III, (braze)		Mode III, (braze)	
%	wt. %	at. %	wt. %	at. %	wt. %	at. %	wt. %	at. %	wt. %	at. %
Al	78.3	79.9	50.4	61.1	50.8	61.5	94.1	94.5	94.2	94.8
Si	18.8	18.4	10.6	12.3	10.3	12.0	5.4	5.2	5.8	5.2
Ti	2.9	1.7	39.0	26.6	38.9	26.5	0.5	0.3	–	–

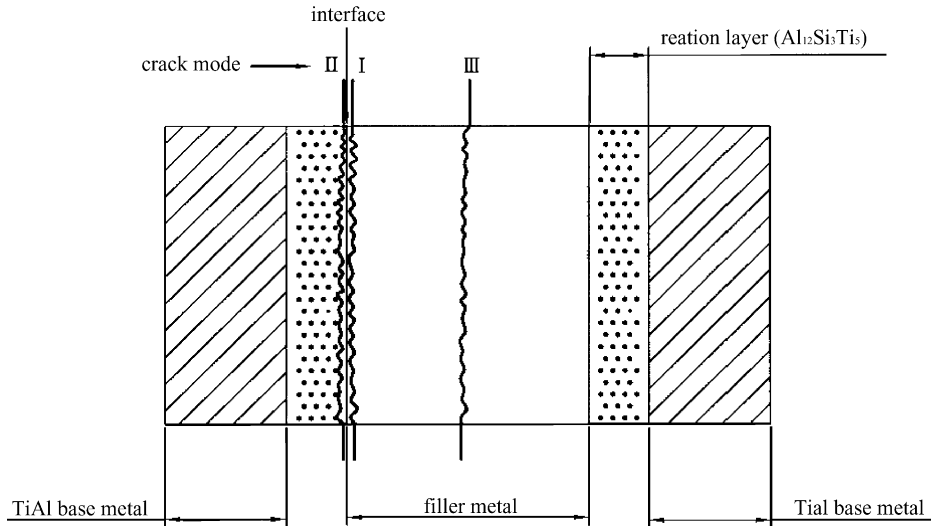


Fig. 12. Three types of failure mode in the shear test.

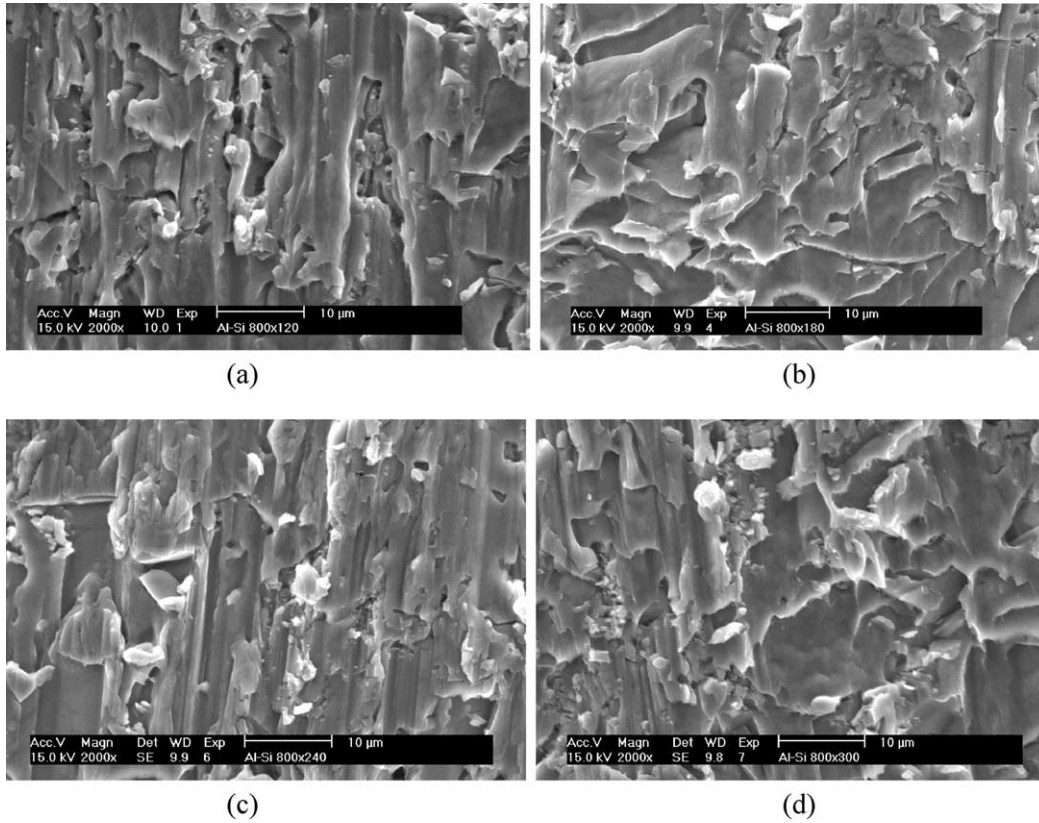


Figure	(a)		(b)		(c)		(d)	
Mode (Location)	Mode I (Interface)		Mode I (Interface)		Mode I (Interface)		Mode I (Interface)	
	wt%	at%	wt%	at%	wt%	At%	wt%	at%
Al	88.2	88.6	86.6	87.0	86.7	87.1	86.0	86.5
Si	11.8	11.4	13.4	13.0	13.3	12.9	14.0	13.5
Ti	---	---	---	---	---	---	---	---

Fig. 13. Chemical analysis and fractographs after shear test for specimens infrared brazed at 800 °C for (a) 120, (b) 180, (c) 240 and (d) 300 s.

cracks are located in the braze alloy as shown in Fig. 11(d) and (e).

Mode I cracks have the lowest shear strength among three failure modes. For all specimens brazed at 800 °C and the specimens brazed at 900 °C below 120 s are featured with mode I failure. With increasing the brazing time at 900 °C, the thickness of $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer is increased, and the fracture mode changes from mode I into mode II. The fractured location changes again from the reaction layer into the braze alloy upon further increment of the brazing time at 900 °C. The shear strength of both mode II and mode III are approximately in the same level. However, the shear strength of mode I is greatly deteriorated. The X-ray analysis of the fractured surface after shear test cannot provide further information due to the insufficient diffraction pattern of the interfacial phases.

Fig. 13 shows the EDS chemical analysis and fractographs after shear test for specimens infrared brazed at 800 °C for 120, 180, 240 and 300 s. Extensive cleavage fractures are observed. According to the EDS analyses, the fractured surface is rich in Si content. Table 2 shows the chemical analysis results of the fractured surfaces after shear test for specimens infrared brazed at 900 °C for 60, 120, 180, 240 and 300 s. It is obvious that all fractured surfaces of mode I failure are rich in Si as demonstrated in Fig. 13 and Table 2. For mode II failure, the chemical composition of the fractured surface can be identified as the $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ phase. It is consistent with the experimental result. Finally, the braze alloy is fractured in mode III failure. Compared with the chemical composition of BAISI-4 braze alloy, the Si content is greatly depleted due to the formation of thick $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ phase at the interface.

4. Conclusion

1. A novel approach in joining TiAl by infrared vacuum brazing using pure aluminum and BAISI-4 filler metal is performed in the study. For pure Al filler metal, extensive presence of the stable TiAl_3 phase in the joint results in inherent brittleness of the bond. Moreover, it is difficult to completely remove the stable TiAl_3 by heat treatment after infrared brazing.
2. For BAISI-4 filler metal, the matrix of the braze alloy is mainly comprised of Al alloyed with minor Si and Ti. Both Si-rich and a few Al–Fe–Si intermetallics are observed in the braze. The transient interfacial AlSi_3Ti_2 phase is only observed in the short brazing cycle. The stable interfacial $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ phase forms initially and grows steadily during infrared brazing. A thin layer of TiAl_2 phase alloyed with minor Si is also observed for longer brazing time.
3. The shear strength increases from 43.2 MPa to 63.9 MPa with the increment of brazing time for specimens brazing at 800 °C. The braze specimens are failed at the interface between $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ phase and braze alloy, and the fractured surface is rich in Si content.
4. The shear strength keeps about the same level upon brazing the specimens at 900 °C for 120–300 s, and its maximum shear strength is 86.2 MPa. For specimen brazing below 120 s, the specimen are fractured at the interface between $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ and braze alloy. With increasing the brazing time, the thickness of $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer increases, and the fracture mode changes from the interface into the continuous $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer. Upon further increasing the brazing time, the fractured location changes again from $\text{Al}_{12}\text{Si}_3\text{Ti}_5$ layer into the braze alloy itself.

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